

LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

SLOS263C – AUGUST 1999 – REVISED MARCH 2000

- **2.7-V and 5-V Performance**
- **No Crossover Distortion**
- **Low Supply Current:**
 LMV321 ... 130 μ A Typ
 LMV358 ... 210 μ A Typ
 LMV324 ... 410 μ A Typ
- **Rail-to-Rail Output Swing**
- **Package Options Include Plastic Small-Outline (D), Small-Outline Transistor (SOT-23 DBV, SC-70 DCK), and Thin Shrink Small-Outline (PW) Packages**

description

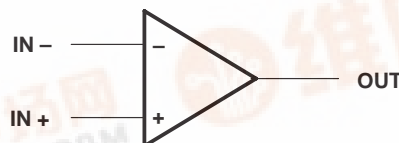
The LMV324 and LMV358 are low-voltage (2.7 V to 5.5 V) versions of the dual and quad operational amplifiers, LM324 and LM358, that operate from 5 V to 30 V. The LMV321 is the single-amplifier version.

The LMV321, LMV324, and LMV358 are the most cost-effective solutions for applications where low-voltage operation, space saving, and low price are needed. They offer specifications that meet or exceed those of the familiar LM358 and LM324 devices. These devices have rail-to-rail output-swing capability, and the input common-mode voltage range includes ground. They all exhibit excellent speed-to-power ratios, achieving 1MHz of bandwidth at 1-V/ μ s slew rate with low supply current.

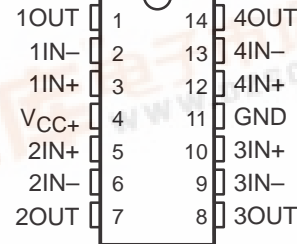
The LMV321 is available in the ultra-small DCK package, which is approximately one-half the size of the DBV package. This package saves space on printed circuit boards and enables the design of small portable electronic devices. It also allows the designer to place the device closer to the signal source to reduce noise pickup and increase signal integrity.

The LMV321I, LMV324I, and LMV358I devices are characterized for operation from -40°C to 85°C .

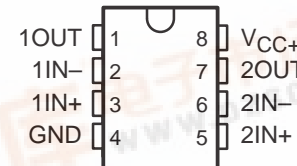
symbol (each amplifier)



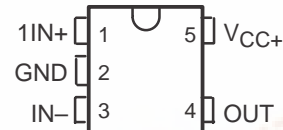
LMV324 ... D OR PW PACKAGE
(TOP VIEW)



LMV358 ... D OR PW PACKAGE
(TOP VIEW)



LMV321 ... DBV OR DCK PACKAGE
(TOP VIEW)



LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

SLOS263C – AUGUST 1999 – REVISED MARCH 2000

AVAILABLE OPTIONS

T _A	PACKAGE TYPE	PACKAGED DEVICES		
		SINGLE	DUAL	QUADRUPL
–40°C to 85°C	5-pin SOT	LMV321IDCKR LMV321IDBVR	— —	— —
	8-pin SOIC	—	LMV358ID	—
	8-pin TSSOP	—	LMV358IPWR	—
	14-pin SOIC	—	—	LMV324ID
	14-pin TSSOP	—	—	LMV324IPWR

The D package is available taped and reeled. Add the suffix R to the device type (e.g., LMV324DR). The DCK, DBV, and PW packages are only available left-end taped and reeled.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC} (see Note 1)	5.5 V
Differential input voltage, V _{ID} (see Note 2)	±5.5 V
Input voltage, V _I (either input)	0 to 5.5 V
Duration of output short circuit (one amplifier) to ground at (or below) T _A = 25°C, V _{CC} ≤ 5.5 V (see Note 3)	Unlimited
Operating virtual junction temperature	150°C
Package thermal impedance, θ _{JA} (see Notes 4 and 5): D (8-pin) package	197°C/W
D (14-pin) package	127°C/W
DBV package	347°C/W
DCK package	389°C/W
PW (8-pin) package	243°C/W
PW (14-pin) package	170°C/W
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: D or PW package	260°C
DBV or DCK package	TBD
Storage temperature range, T _{stg}	–65 to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. All voltage values (except differential voltages and V_{CC} specified for the measurement of I_{OS}) are with respect to the network GND.
 2. Differential voltages are at IN+ with respect to IN–.
 3. Short circuits from outputs to V_{CC} can cause excessive heating and eventual destruction.
 4. Maximum power dissipation is a function of T_{J(max)}, θ_{JA}, and T_A. The maximum allowable power dissipation at any allowable ambient temperature is P_D = (T_{J(max)} – T_A)/θ_{JA}. Selecting the maximum of 150°C can impact reliability.
 5. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions

	MIN	MAX	UNIT
V _{CC} Supply voltage (single-supply operation)	2.7	5.5	V
T _A Operating free-air temperature	–40	85	°C

LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

SLOS263C – AUGUST 1999 – REVISED MARCH 2000

electrical characteristics at $T_A = 25^\circ\text{C}$ and $V_{CC+} = 2.7\text{ V}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
V_{IO}	Input offset voltage			1.7	7	mV
$\alpha_{V_{IO}}$	Average temperature coefficient of input offset voltage			5		$\mu\text{V}/^\circ\text{C}$
I_{IB}	Input bias current			11	250	nA
I_{IO}	Input offset current			5	50	nA
CMRR	Common-mode rejection ratio	$V_{CM} = 0$ to 1.7 V	50	63		dB
k_{SVR}	Supply-voltage rejection ratio	$V_{CC} = 2.7\text{ V}$ to 5 V , $V_O = 1\text{ V}$	50	60		dB
V_{ICR}	Common-mode input voltage range	CMRR $\geq 50\text{ dB}$	0 to 1.7	-0.2 to 1.9		V
Output swing		$R_L = 10\text{ k}\Omega$ to 1.35 V	High level	$V_{CC}-100$	$V_{CC}-10$	mV
			Low level	60	180	
I_{CC}	Supply current	LMV321I		80	170	μA
		LMV358I (both amplifiers)		140	340	
		LMV324I (all four amplifiers)		260	680	
B_1	Unity-gain bandwidth	$C_L = 200\text{ pF}$		1		MHz
Φ_m	Phase margin			60		deg
G_m	Gain margin			10		dB
V_n	Equivalent input noise voltage	$f = 1\text{ kHz}$		46		$\text{nV}/\sqrt{\text{Hz}}$
I_n	Equivalent input noise current	$f = 1\text{ kHz}$		0.17		$\text{pA}/\sqrt{\text{Hz}}$

LMV321 SINGLE, LMV358 DUAL, LMV324 QUAD LOW-VOLTAGE RAIL-TO-RAIL OUTPUT OPERATIONAL AMPLIFIERS

SLOS263C – AUGUST 1999 – REVISED MARCH 2000

electrical characteristics at specified free-air temperature range, $V_{CC+} = 5\text{ V}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T_A	MIN	TYP	MAX	UNIT
V_{IO} Input offset voltage		25°C		1.7	7	mV
		–40°C to 85°C			9	
$\alpha_{V_{IO}}$ Average temperature coefficient of input offset voltage		25°C		5		$\mu\text{V}/^\circ\text{C}$
I_{IB} Input bias current		25°C		15	250	nA
		–40°C to 85°C			500	
I_{IO} Input offset current		25°C		5	50	nA
		–40°C to 85°C			150	
CMRR Common-mode rejection ratio	$V_{CM} = 0\text{ to }4\text{ V}$	25°C	50	65		dB
k_{SVR} Supply-voltage rejection ratio	$V_{CC} = 2.7\text{ V to }5\text{ V}$, $V_O = 1\text{ V}$, $V_{CM} = 1\text{ V}$	25°C	50	60		dB
V_{ICR} Common-mode input voltage range	CMMR $\geq 50\text{ dB}$	25°C	0 to 4	–0.2 to 4.2		V
Output swing	$R_L = 2\text{ k}\Omega\text{ to }2.5\text{ V}$	High level	25°C	$V_{CC}-300$	$V_{CC}-40$	mV
		Low level	–40°C to 85°C	$V_{CC}-400$		
			25°C		120	
			–40°C to 85°C		400	
	$R_L = 10\text{ k}\Omega\text{ to }2.5\text{ V}$	High level	25°C	$V_{CC}-100$	$V_{CC}-10$	
		Low level	–40°C to 85°C	$V_{CC}-200$		
			25°C		65	
			–40°C to 85°C		280	
A_{VD} Large-signal differential voltage gain	$R_L = 2\text{ k}\Omega$	25°C	15	100		V/mV
		–40°C to 85°C	10			
I_{OS} Output short-circuit current	Sourcing, $V_O = 0\text{ V}$	25°C	5	60		mA
	Sinking, $V_O = 5\text{ V}$		10	160		
I_{CC} Supply current	LMV321	25°C		130	250	μA
		–40°C to 85°C			350	
	LMV358 (both amplifiers)	25°C		210	440	
		–40°C to 85°C			615	
	LMV324 (all four amplifiers)	25°C		410	830	
		–40°C to 85°C			1160	
B_1 Unity-gain bandwidth	$C_L = 200\text{ pF}$	25°C		1		MHz
ϕ_m Phase margin		25°C		60		deg
G_m Gain margin		25°C		10		dB
V_n Equivalent input noise voltage	$f = 1\text{ kHz}$	25°C		39		$\text{nV}/\sqrt{\text{Hz}}$
I_n Equivalent input noise current	$f = 1\text{ kHz}$	25°C		0.21		$\text{pA}/\sqrt{\text{Hz}}$
SR Slew rate		25°C		1		$\text{V}/\mu\text{s}$

IMPORTANT NOTICE

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.